

NTA4001N

Small Signal MOSFET

20 V, 238 mA, Single, N-Channel, Gate ESD Protection, SC-75

Features

- Low Gate Charge for Fast Switching
- Small 1.6 X 1.6 mm Footprint
- ESD Protected Gate
- Pb-Free Package for "Green Manufacturing" Compliance

Applications

- Power Management Load Switch
- Level Shift
- Portable Applications such as Cell Phones, Media Players, Digital Cameras, PDA's, Video Games, Hand Held Computers, etc.

Maximum Ratings (T_J = 25°C unless otherwise stated)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	20	V
Gate-to-Source Voltage		V _{GS}	±10	V
Continuous Drain Current (Note 1)	Steady State = 25°C	I _D	238	mA
Power Dissipation (Note 1)	Steady State = 25°C	P _D	300	mW
Pulsed Drain Current	t _p ≤ 10 μs	I _{DM}	714	mA
Operating Junction and Storage Temperature		T _J , T _{STG}	-55 to 150	°C
Continuous Source Current (Body Diode)		I _{SD}	238	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T _L	260	°C

Thermal Resistance Ratings

Parameter	Symbol	Max	Unit
Junction-to-Ambient – Steady State (Note 1)	R _{θJA}	416	°C/W

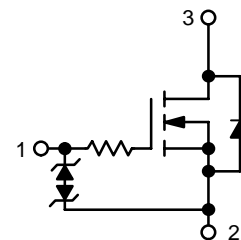
1. Surface-mounted on FR4 board using 1 in sq. pad size (Cu area = 1.127 in sq. [1 oz] including traces).



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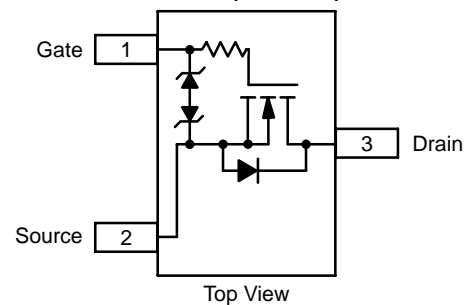
<http://onsemi.com>

V _{(BR)DSS}	R _{DS(on)} Typ @ V _{GS}	I _D MAX (Note 1)
20 V	1.5 Ω @ 4.5 V	238 mA
	2.2 Ω @ 2.5 V	

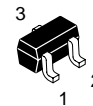


N-Channel

SC-75 (3-Leads)

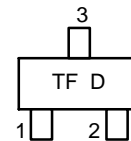


Top View



SC-75 / SOT-416
CASE 463
Style 5

MARKING DIAGRAM



TF = Specific Device Code
D = Date Code

ORDERING INFORMATION

Device	Package	Shipping
NTA4001NT1	SC-75	3000 / Tape & Reel
NTA4001NT1G	SC-75 Pb-Free	3000 / Tape & Reel

NTA4001N

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 100 μA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 20 V			1.0	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±10 V			±100	μA

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	V _{GS(TH)}	V _{DS} = 3 V, I _D = 100 μA	0.5	1.0	1.5	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 mA		1.5	3.0	Ω
		V _{GS} = 2.5 V, I _D = 10 mA		2.2	3.5	
Forward Transconductance	g _{FS}	V _{DS} = 3 V, I _D = 10 mA		80		mS

CAPACITANCES

Input Capacitance	C _{ISS}	V _{DS} = 5 V, f = 1 MHz, V _{GS} = 0 V		11.5		pF
Output Capacitance	C _{OSS}			10		
Reverse Transfer Capacitance	C _{RSS}			3.5		

SWITCHING CHARACTERISTICS (Note 3)

Turn-On Delay Time	t _{d(ON)}	V _{GS} = 4.5 V, V _{DS} = 5 V, I _D = 10 mA, R _G = 10 Ω		13		ns
Rise Time	t _r			15		
Turn-Off Delay Time	t _{d(OFF)}			98		ns
Fall Time	t _f			60		

Drain-Source Diode Characteristics

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 mA		0.66	0.8	V
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NOTES:

- Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Switching characteristics are independent of operating junction temperatures.

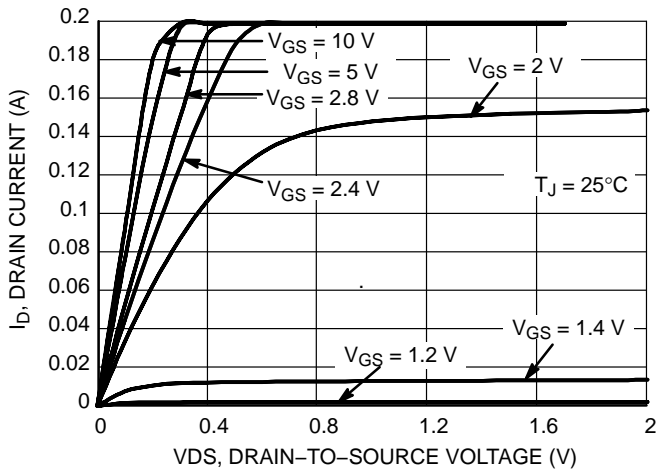


Figure 1. On-region Characteristics

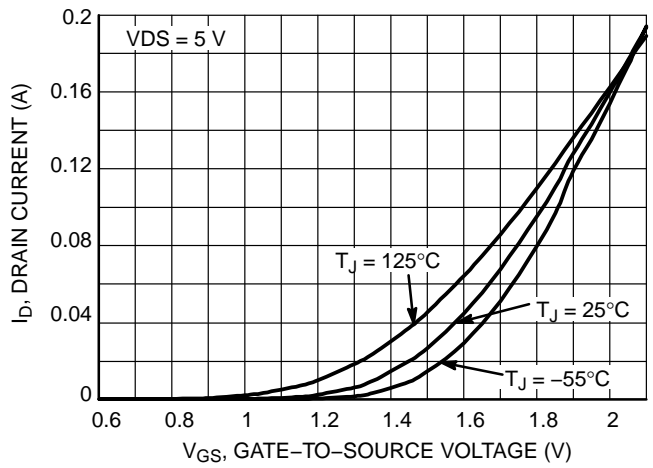


Figure 2. Transfer Characteristics

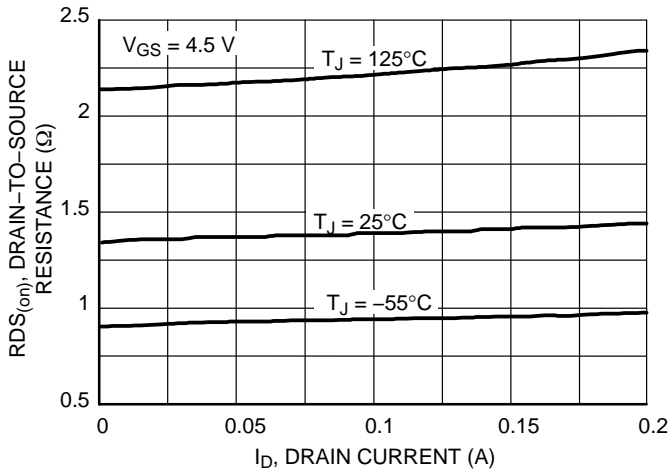


Figure 3. On-resistance versus Drain Current and Temperature

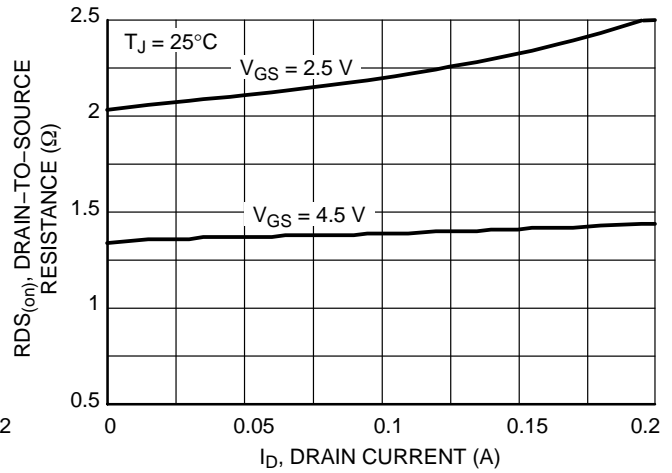


Figure 4. On-resistance versus Drain Current and Gate Voltage

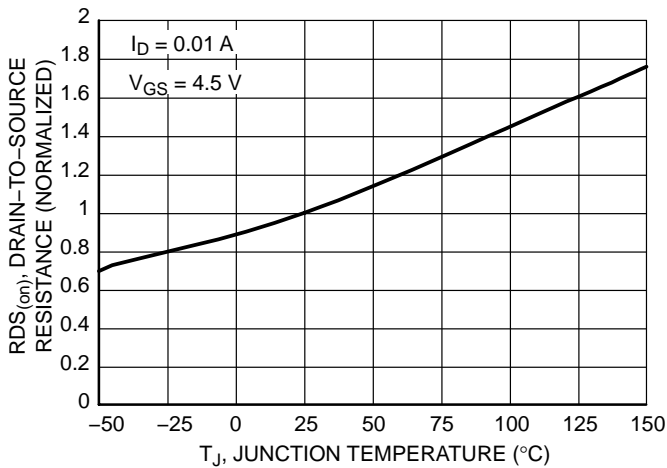


Figure 5. On-resistance Variation with Temperature

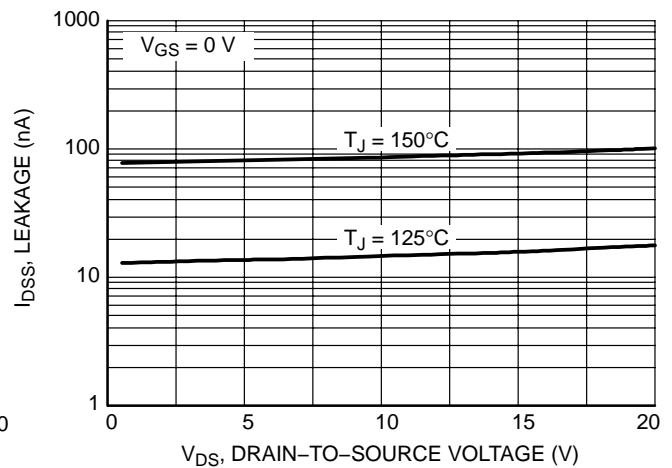
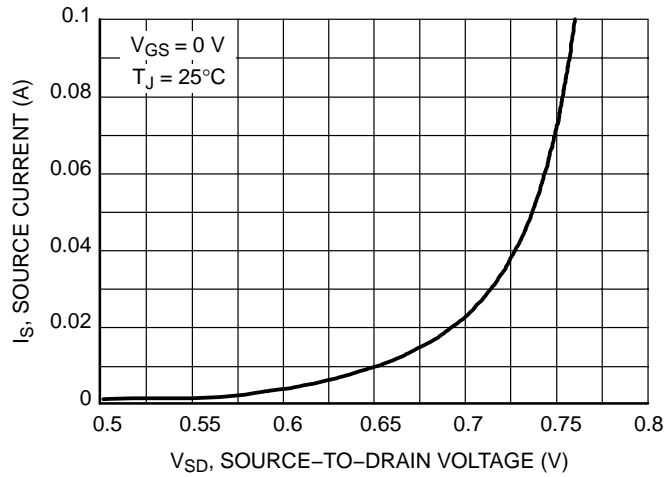
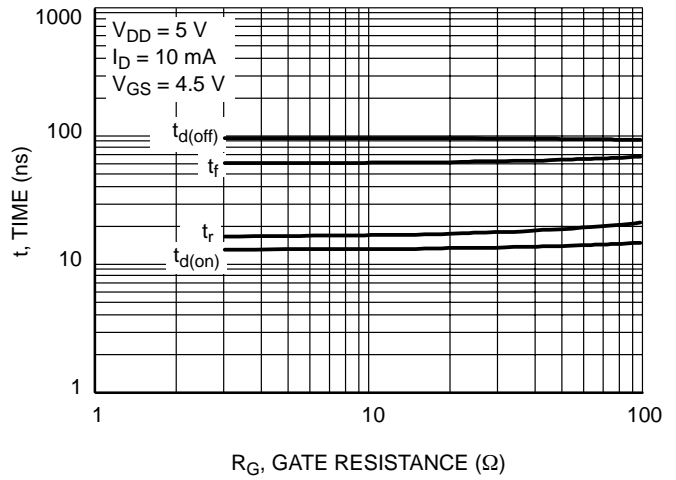
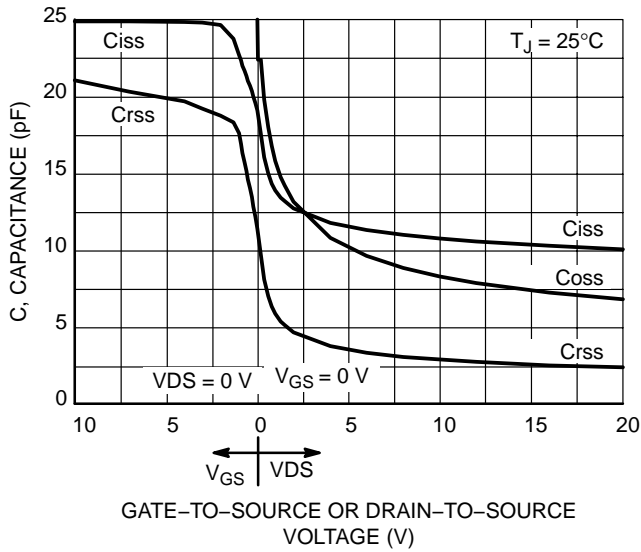


Figure 6. Drain-to-Source Leakage Current versus Voltage

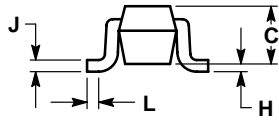
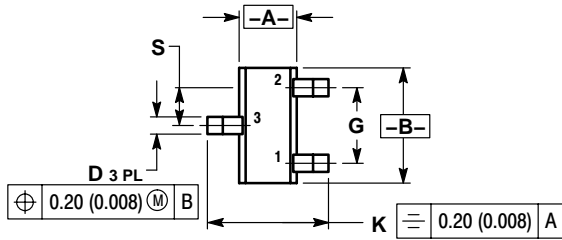
NTA4001N



NTA4001N

PACKAGE DIMENSIONS

SC-75 / SOT-416
CASE 463-01
ISSUE C



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.70	0.90	0.028	0.035
B	1.40	1.80	0.055	0.071
C	0.60	0.90	0.024	0.035
D	0.15	0.30	0.006	0.012
G	1.00 BSC		0.039 BSC	
H	---	0.10	---	0.004
J	0.10	0.25	0.004	0.010
K	1.45	1.75	0.057	0.069
L	0.10	0.20	0.004	0.008
S	0.50 BSC		0.020 BSC	

STYLE 5:

- PIN 1. GATE
2. SOURCE
3. DRAIN

NTA4001N

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